

# Quad 2-Input NOR Gate With 5V-Tolerant Inputs

The MC74LVX02 is an advanced high speed CMOS 2-input NOR gate. The inputs tolerate voltages up to 7V, allowing the interface of 5V systems to 3V systems.

- High Speed:  $t_{PD} = 4.5\text{ns}$  (Typ) at  $V_{CC} = 3.3\text{V}$
- Low Power Dissipation:  $I_{CC} = 2\mu\text{A}$  (Max) at  $T_A = 25^\circ\text{C}$
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Low Noise:  $V_{OLP} = 0.5\text{V}$  (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300mA
- ESD Performance: HBM > 2000V; Machine Model > 200V

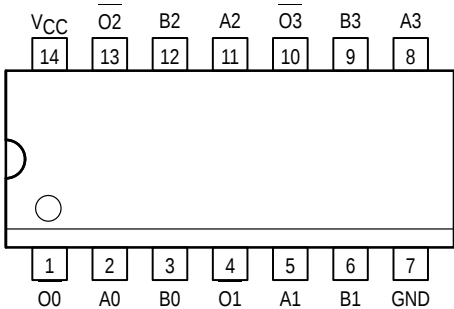


Figure 1. 14-Lead Pinout (Top View)

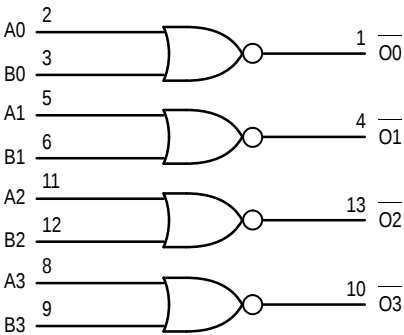


Figure 2. Logic Diagram

MC74LVX02

LVX

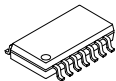
LOW-VOLTAGE CMOS



D SUFFIX  
14-LEAD SOIC PACKAGE  
CASE 751A-03



DT SUFFIX  
14-LEAD TSSOP PACKAGE  
CASE 948G-01



M SUFFIX  
14-LEAD SOIC EIAJ PACKAGE  
CASE 965-01

### PIN NAMES

| Pins                                | Function    |
|-------------------------------------|-------------|
| $\overline{A_n}$ , $\overline{B_n}$ | Data Inputs |
| $\overline{O_n}$                    | Outputs     |

### FUNCTION TABLE

| INPUTS           |                  | OUTPUTS          |
|------------------|------------------|------------------|
| $\overline{A_n}$ | $\overline{B_n}$ | $\overline{O_n}$ |
| L                | L                | H                |
| L                | H                | L                |
| H                | L                | L                |
| H                | H                | L                |



**MAXIMUM RATINGS\***

| Symbol           | Parameter                                       | Value                        | Unit |
|------------------|-------------------------------------------------|------------------------------|------|
| V <sub>CC</sub>  | DC Supply Voltage                               | −0.5 to +7.0                 | V    |
| V <sub>in</sub>  | DC Input Voltage                                | −0.5 to +7.0                 | V    |
| V <sub>out</sub> | DC Output Voltage                               | −0.5 to V <sub>CC</sub> +0.5 | V    |
| I <sub>IK</sub>  | Input Diode Current                             | −20                          | mA   |
| I <sub>OK</sub>  | Output Diode Current                            | ±20                          | mA   |
| I <sub>out</sub> | DC Output Current, per Pin                      | ±25                          | mA   |
| I <sub>CC</sub>  | DC Supply Current, V <sub>CC</sub> and GND Pins | ±50                          | mA   |
| P <sub>D</sub>   | Power Dissipation                               | 180                          | mW   |
| T <sub>stg</sub> | Storage Temperature                             | −65 to +150                  | °C   |

\* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute–maximum–rated conditions is not implied.

**RECOMMENDED OPERATING CONDITIONS**

| Symbol           | Parameter                                | Min | Max             | Unit |
|------------------|------------------------------------------|-----|-----------------|------|
| V <sub>CC</sub>  | DC Supply Voltage                        | 2.0 | 3.6             | V    |
| V <sub>in</sub>  | DC Input Voltage                         | 0   | 5.5             | V    |
| V <sub>out</sub> | DC Output Voltage                        | 0   | V <sub>CC</sub> | V    |
| T <sub>A</sub>   | Operating Temperature, All Package Types | −40 | +85             | °C   |
| Δt/ΔV            | Input Rise and Fall Time                 | 0   | 100             | ns/V |

**DC ELECTRICAL CHARACTERISTICS**

| Symbol          | Parameter                                                                            | Test Conditions                                                              | V <sub>CC</sub><br>V | T <sub>A</sub> = 25°C |            |                    | T <sub>A</sub> = −40 to 85°C |                    | Unit |
|-----------------|--------------------------------------------------------------------------------------|------------------------------------------------------------------------------|----------------------|-----------------------|------------|--------------------|------------------------------|--------------------|------|
|                 |                                                                                      |                                                                              |                      | Min                   | Typ        | Max                | Min                          | Max                |      |
| V <sub>IH</sub> | High–Level Input Voltage                                                             |                                                                              | 2.0<br>3.0<br>3.6    | 1.5<br>2.0<br>2.4     |            |                    | 1.5<br>2.0<br>2.4            |                    | V    |
| V <sub>IL</sub> | Low–Level Input Voltage                                                              |                                                                              | 2.0<br>3.0<br>3.6    |                       |            | 0.5<br>0.8<br>0.8  |                              | 0.5<br>0.8<br>0.8  | V    |
| V <sub>OH</sub> | High–Level Output Voltage<br>(V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub> ) | I <sub>OH</sub> = −50μA<br>I <sub>OH</sub> = −50μA<br>I <sub>OH</sub> = −4mA | 2.0<br>3.0<br>3.0    | 1.9<br>2.9<br>2.58    | 2.0<br>3.0 |                    | 1.9<br>2.9<br>2.48           |                    | V    |
| V <sub>OL</sub> | Low–Level Output Voltage<br>(V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub> )  | I <sub>OL</sub> = 50μA<br>I <sub>OL</sub> = 50μA<br>I <sub>OL</sub> = 4mA    | 2.0<br>3.0<br>3.0    |                       | 0.0<br>0.0 | 0.1<br>0.1<br>0.36 |                              | 0.1<br>0.1<br>0.44 | V    |
| I <sub>in</sub> | Input Leakage Current                                                                | V <sub>in</sub> = 5.5V or GND                                                | 3.6                  |                       |            | ±0.1               |                              | ±1.0               | μA   |
| I <sub>CC</sub> | Quiescent Supply Current                                                             | V <sub>in</sub> = V <sub>CC</sub> or GND                                     | 3.6                  |                       |            | 2.0                |                              | 20.0               | μA   |

**AC ELECTRICAL CHARACTERISTICS** (Input  $t_r = t_f = 3.0\text{ns}$ )

| Symbol                   | Parameter                              | Test Conditions                                                                                  | $T_A = 25^\circ\text{C}$ |            |              | $T_A = -40 \text{ to } 85^\circ\text{C}$ |              | Unit |
|--------------------------|----------------------------------------|--------------------------------------------------------------------------------------------------|--------------------------|------------|--------------|------------------------------------------|--------------|------|
|                          |                                        |                                                                                                  | Min                      | Typ        | Max          | Min                                      | Max          |      |
| $t_{PLH}$ ,<br>$t_{PHL}$ | Propagation Delay, Input to Output     | $V_{CC} = 2.7\text{V}$ $C_L = 15\text{pF}$<br>$C_L = 50\text{pF}$                                |                          | 5.9<br>8.4 | 10.7<br>14.2 | 1.0<br>1.0                               | 13.5<br>17.0 | ns   |
|                          |                                        | $V_{CC} = 3.3 \pm 0.3\text{V}$ $C_L = 15\text{pF}$<br>$C_L = 50\text{pF}$                        |                          | 4.5<br>7.0 | 6.6<br>10.1  | 1.0<br>1.0                               | 8.0<br>11.5  |      |
| $t_{OSHL}$<br>$t_{OSLH}$ | Output-to-Output Skew<br>(Note NO TAG) | $V_{CC} = 2.7\text{V}$ $C_L = 50\text{pF}$<br>$V_{CC} = 3.3 \pm 0.3\text{V}$ $C_L = 50\text{pF}$ |                          |            | 1.5<br>1.5   |                                          | 1.5<br>1.5   | ns   |

1. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW ( $t_{OSHL}$ ) or LOW-to-HIGH ( $t_{OSLH}$ ); parameter guaranteed by design.

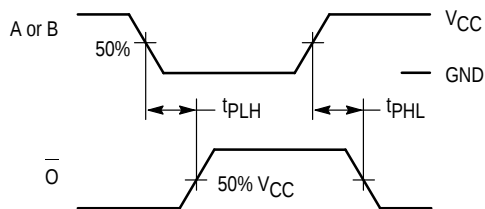
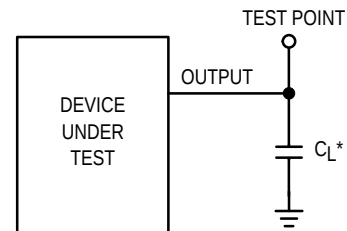
**CAPACITIVE CHARACTERISTICS**

| Symbol   | Parameter                                   | $T_A = 25^\circ\text{C}$ |     |     | $T_A = -40 \text{ to } 85^\circ\text{C}$ |     | Unit |
|----------|---------------------------------------------|--------------------------|-----|-----|------------------------------------------|-----|------|
|          |                                             | Min                      | Typ | Max | Min                                      | Max |      |
| $C_{in}$ | Input Capacitance                           |                          | 4   | 10  |                                          | 10  | pF   |
| $C_{PD}$ | Power Dissipation Capacitance (Note NO TAG) |                          | 15  |     |                                          |     | pF   |

2.  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:  $I_{CC(OPR)} = C_{PD} \cdot V_{CC} \cdot f_{in} + I_{CC}/4$  (per gate).  $C_{PD}$  is used to determine the no-load dynamic power consumption;  $P_D = C_{PD} \cdot V_{CC}^2 \cdot f_{in} + I_{CC} \cdot V_{CC}$ .

**NOISE CHARACTERISTICS** (Input  $t_r = t_f = 3.0\text{ns}$ ,  $C_L = 50\text{pF}$ ,  $V_{CC} = 3.3\text{V}$ , Measured in SOIC Package)

| Symbol    | Characteristic                           | $T_A = 25^\circ\text{C}$ |      | Unit |
|-----------|------------------------------------------|--------------------------|------|------|
|           |                                          | Typ                      | Max  |      |
| $V_{OLP}$ | Quiet Output Maximum Dynamic $V_{OL}$    | 0.3                      | 0.5  | V    |
| $V_{OLV}$ | Quiet Output Minimum Dynamic $V_{OL}$    | -0.3                     | -0.5 | V    |
| $V_{IHD}$ | Minimum High Level Dynamic Input Voltage |                          | 2.0  | V    |
| $V_{ILD}$ | Maximum Low Level Dynamic Input Voltage  |                          | 0.8  | V    |

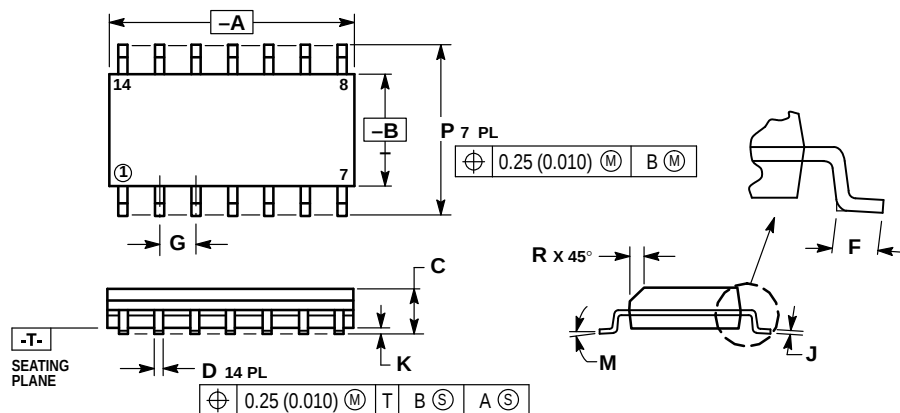
**Figure 3. Switching Waveforms**

\* Includes all probe and jig capacitance

**Figure 4. Test Circuit**

## OUTLINE DIMENSIONS

**D SUFFIX**  
**PLASTIC SOIC PACKAGE**  
**CASE 751A-03**  
**ISSUE F**

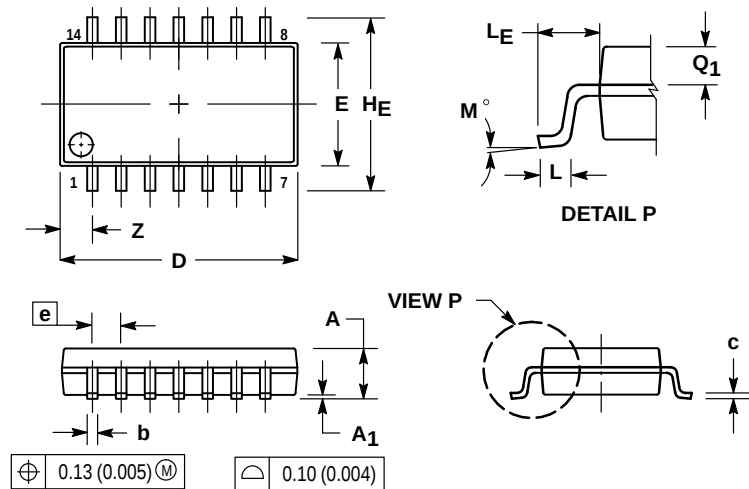


## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 8.55        | 8.75 | 0.337     | 0.344 |
| B   | 3.80        | 4.00 | 0.150     | 0.157 |
| C   | 1.35        | 1.75 | 0.054     | 0.068 |
| D   | 0.35        | 0.49 | 0.014     | 0.019 |
| F   | 0.40        | 1.25 | 0.016     | 0.049 |
| G   | 1.27 BSC    |      | 0.050 BSC |       |
| J   | 0.19        | 0.25 | 0.008     | 0.009 |
| K   | 0.10        | 0.25 | 0.004     | 0.009 |
| M   | 0°          | 7°   | 0°        | 7°    |
| P   | 5.80        | 6.20 | 0.228     | 0.244 |
| R   | 0.25        | 0.50 | 0.010     | 0.019 |

**M SUFFIX**  
**PLASTIC SOIC EIAJ PACKAGE**  
**CASE 965-01**  
**ISSUE O**



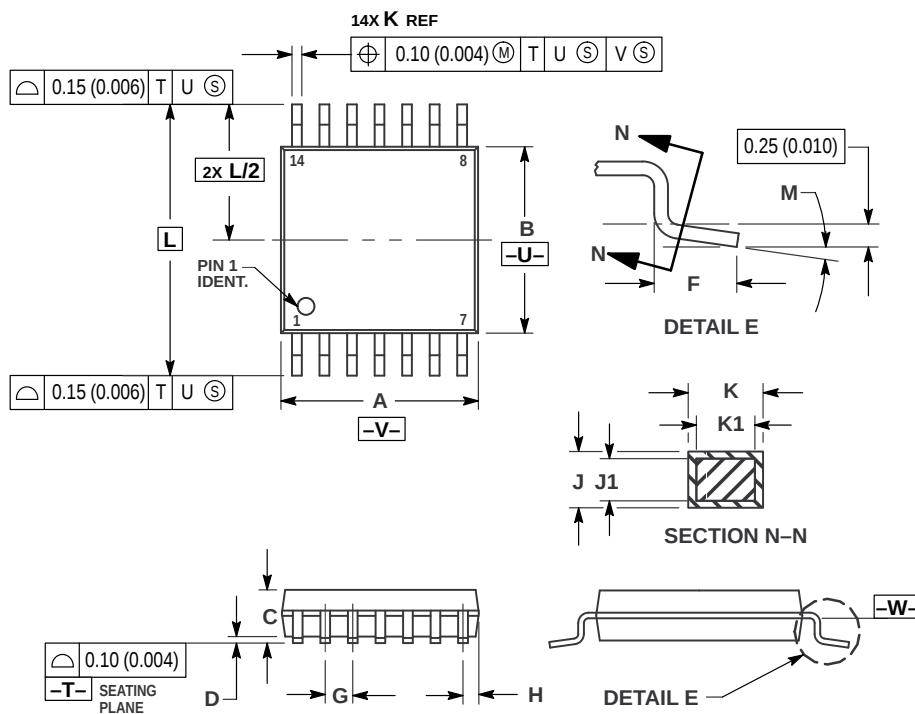
## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

| DIM            | MILLIMETERS |       | INCHES    |       |
|----------------|-------------|-------|-----------|-------|
|                | MIN         | MAX   | MIN       | MAX   |
| A              | ---         | 2.05  | ---       | 0.081 |
| A <sub>1</sub> | 0.05        | 0.20  | 0.002     | 0.008 |
| b              | 0.35        | 0.50  | 0.014     | 0.020 |
| c              | 0.18        | 0.27  | 0.007     | 0.011 |
| D              | 9.90        | 10.50 | 0.390     | 0.413 |
| E              | 5.10        | 5.45  | 0.201     | 0.215 |
| e              | 1.27 BSC    |       | 0.050 BSC |       |
| H <sub>E</sub> | 7.40        | 8.20  | 0.291     | 0.323 |
| L              | 0.50        | 0.85  | 0.020     | 0.033 |
| L <sub>E</sub> | 1.10        | 1.50  | 0.043     | 0.059 |
| M              | 0°          | 10°   | 0°        | 10°   |
| Q <sub>1</sub> | 0.70        | 0.90  | 0.028     | 0.035 |
| Z              | ---         | 1.42  | ---       | 0.056 |

## OUTLINE DIMENSIONS

**DT SUFFIX**  
**PLASTIC TSSOP PACKAGE**  
**CASE 948G-01**  
**ISSUE O**



## NOTES:

- 1 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2 CONTROLLING DIMENSION: MILLIMETER.
- 3 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- 4 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
- 5 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 6 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 7 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 4.90        | 5.10 | 0.193     | 0.200 |
| B   | 4.30        | 4.50 | 0.169     | 0.177 |
| C   | —           | 1.20 | —         | 0.047 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.50        | 0.75 | 0.020     | 0.030 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| H   | 0.50        | 0.60 | 0.020     | 0.024 |
| J   | 0.09        | 0.20 | 0.004     | 0.008 |
| J1  | 0.09        | 0.16 | 0.004     | 0.006 |
| K   | 0.19        | 0.30 | 0.007     | 0.012 |
| K1  | 0.19        | 0.25 | 0.007     | 0.010 |
| L   | 6.40 BSC    |      | 0.252 BSC |       |
| M   | 0°          | 8°   | 0°        | 8°    |

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters which may be provided in Motorola data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part. Motorola and  are registered trademarks of Motorola, Inc. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

Mfax is a trademark of Motorola, Inc.

**How to reach us:**

**USA/EUROPE/Locations Not Listed:** Motorola Literature Distribution;  
P.O. Box 5405, Denver, Colorado 80217. 303-675-2140 or 1-800-441-2447

**JAPAN:** Nippon Motorola Ltd.: SPD, Strategic Planning Office, 4-32-1,  
Nishi-Gotanda, Shinagawa-ku, Tokyo 141, Japan. 81-3-5487-8488

**Mfax™:** RMFAX0@email.sps.mot.com — TOUCHTONE 602-244-6609  
— US & Canada ONLY 1-800-774-1848

**ASIA/PACIFIC:** Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park,  
51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852-26629298

**INTERNET:** <http://motorola.com/sps>

